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FDB035N10A N 沟道 PowerTrench[®] MOSFET **100 V**, **214 A**, **3.5 m** Ω

特性

- R_{DS(on)} = 3.0 mΩ (典型值) @ V_{GS} = 10 V, I_D = 75 A
- 快速开关速度
- 低栅极电荷, Q_G = 89 nC (典型值)
- 高性能沟道技术可实现极低的 R_{DS(on)}
- 高功率和高电流处理能力
- 符合 RoHS 标准

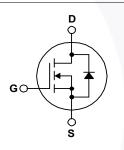
说明

此 N 沟道 MOSFET 采用飞兆半导体先进的 Power Trench[®] 工 艺生产,这一先进工艺是专为最大限度地降低导通电阻并保持卓 越开关性能而定制的。

应用

- 用于 ATX/ 服务器 / 电信 PSU 的同步整流
- 电池保护电路
- 电机驱动和不间断电源
- 微型太阳能逆变器





MOSFET 最大额定值 T_C = 25℃ 除非另有说明。

符号	参数			FDB035N10A	単位	
V _{DSS}	漏极一源极电压			100	V	
V _{GSS}	栅极一源极电压			±20	V	
ID	-	连续(T _C = 25°C,硅限制)		214*	А	
	漏极电流 -	连续(T _C = 100°C,硅限制)		151*		
	-	连续 (T _C = 25°C,封装限制)		120		
DM	漏极电流 -	脉冲	(说明1)	856	А	
E _{AS}	单脉冲雪崩能量 (说明 2)		(说明2)	658	mJ	
dv/dt	二极管恢复 dv/dt 峰值 (说明 3)			6.0	V/ns	
P _D	-+ +*	T _C = 25°C)		333	W	
	功耗 -	降低至 25°C 以上		2.22	W/°C	
T _J , T _{STG}	工作和存储温度范围			-55 至 +175	°C	
ΓL	用于焊接的最大引线温度,距离外壳 1/8",持续 5 秒			300	°C	
计算连续电流	(基于最高允许结温)。封装限制电流为 12	20 A.				

热性能

符号	参数	FDB035N10A	单位
$R_{ ext{ heta}JC}$	结至外壳热阻最大值	0.45	
В	结至环境热阻 (最小尺寸的2盎司焊盘)最大值。	62.5	°C/W
$R_{ extsf{ heta}JA}$	结至环境热阻 (1 in ² 2 盎司焊盘)最大值。	40	

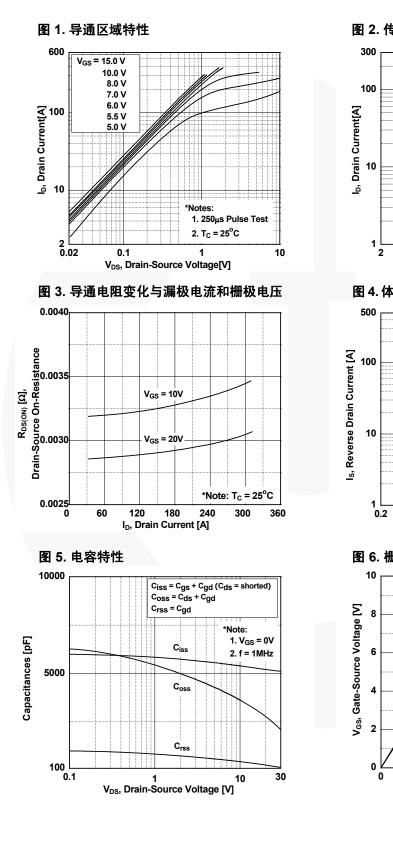
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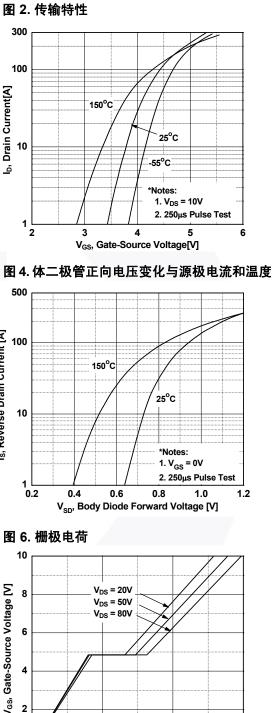
		封装	包装方法	卷尺寸		带宽	数	₽	
		D ² -PAK			24 mm		800个		
由有性学			1		1				
モー1行 II 符号	$T_{\rm C} = 25^{\circ}{\rm C}$	除非另有说明。		测试条件	<u> </u>	最小值	典型值	最大值	单位
关断特性		7		<i>於</i> 引以不口	-	取小但	天空道	取八旦	二 千口
BV _{DSS}	定扣 派	极击穿电压				100	<u> </u>	1	V
∆BV _{DSS}				I _D = 250 μA, V _{GS} = 0 V, T _C = 25°C		100	-	-	v
ΔDV _{DSS} /ΔT _J	击穿电压温度系数			I _D = 250 μA,温度参考 25°C		-	0.07	-	V/°C
		零栅极电压漏极电流		V _{DS} = 80 V, V _{GS} = 0 V V _{DS} = 80 V, T _C = 150°C		-	-	1	1 500 μA
IDSS	零栅极电					-	-	500	
I _{GSS}	栅极 - 体	漏电流		$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$	V	-	-	±100	nA
导通特性									
V _{GS(th)}	栅极阈值电压			V _{GS} = V _{DS} , I _D = 250 μA		2.0	-	4.0	V
R _{DS(on)}	漏极至源			$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$		-	3.0	3.5	mΩ
9 _{FS}	正向跨导	}		V _{DS} = 10 V, I _D = 75 A		-	167	-	S
动态特性									
C _{iss}	输入电容	F		V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	5485	7295	pF
C _{oss}	输出电容	ŝ				-	2430	3230	pF
C _{rss}	反向传输	间电容				-	210	-	pF
Q _{g(tot)}	10 V 的标	册极电荷总量		V _{DS} = 80 V, I _D = 75 A, V _{GS} = 10 V		-	89	116	nC
Q _{gs}	栅极 - 源	极栅极电荷				-	24	-	nC
Q _{gs2}	栅极平台	1电荷阈值				-	8	-	nC
Q _{gd}	栅极 - 漏	极 " 米勒 " 电荷				-	25	-	nC
开关特性									
t _{d(on)}	导通延迟	时间		V _{DD} = 50 V, I _D = 75 A, V _{GS} = 10 V, R _G = 4.7 Ω (说明 4)		-	22	54	ns
t _r	开通上升	·时间				-	54	118	ns
t _{d(off)}	关断延迟	时间				-	37	84	ns
t _f	关断下降	时间				- /	11	32	ns
ESR	等效串联	电阻 (G-S)		f = 1 MHz		-	1.2	-	Ω
漏极 - 源极	上极管特	性							
I _S		极二极管最大正向连续的	も流			-	-	214*	A
I _{SM}	漏极 - 源极二极管最大正向脉冲电流					-	-	856	Α
V _{SD}		极二极管正向电压		V _{GS} = 0 V, I _{SD} = 75 A		-	-	1.25	V
t _{rr}	反向恢复			V _{GS} = 0 V, I _{SD} = 75 A,	V _{DD} = 80 V,	-	72	-	ns
Q _{rr}	反向恢复		$dI_{F}/dt = 100 \text{ A}/\mu\text{s}$		-	129	-	nC	

FDB035N10AN 沟道 PowerTrench[®] MOSFET

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典型性能特征





FDB035N10AN 沟道 PowerTrench[®] MOSFET

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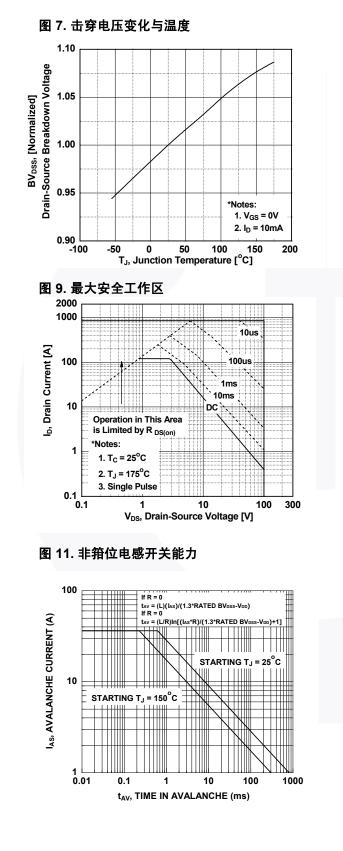
*Note: I_D = 75A

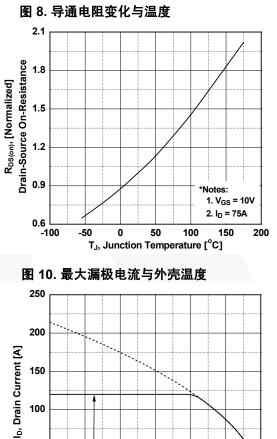
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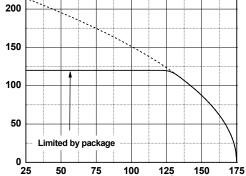
Q_q, Total Gate Charge [nC]

30

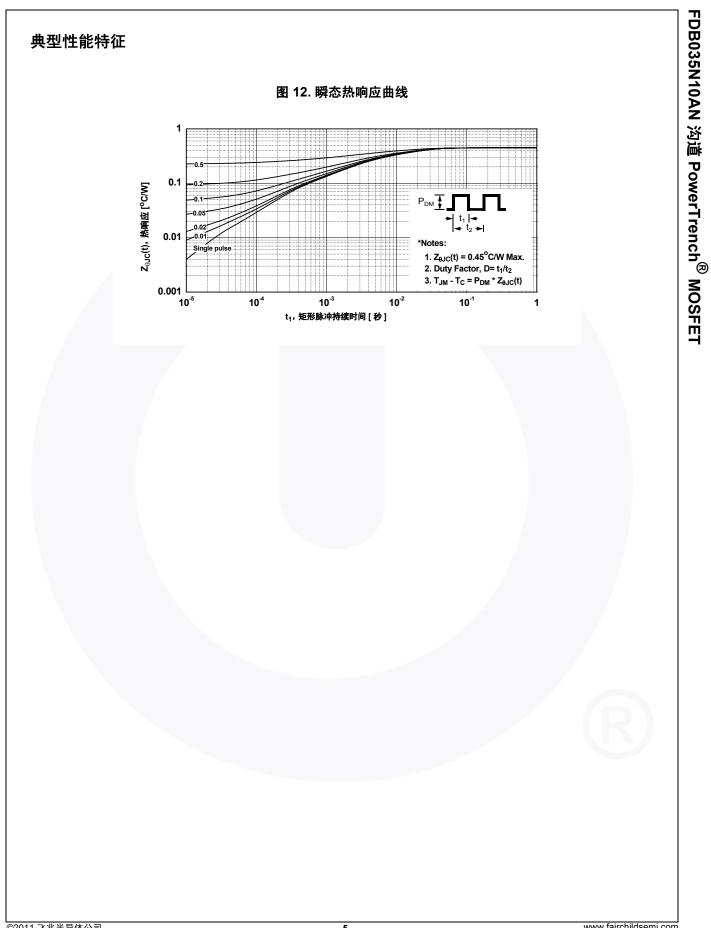
典型性能特征

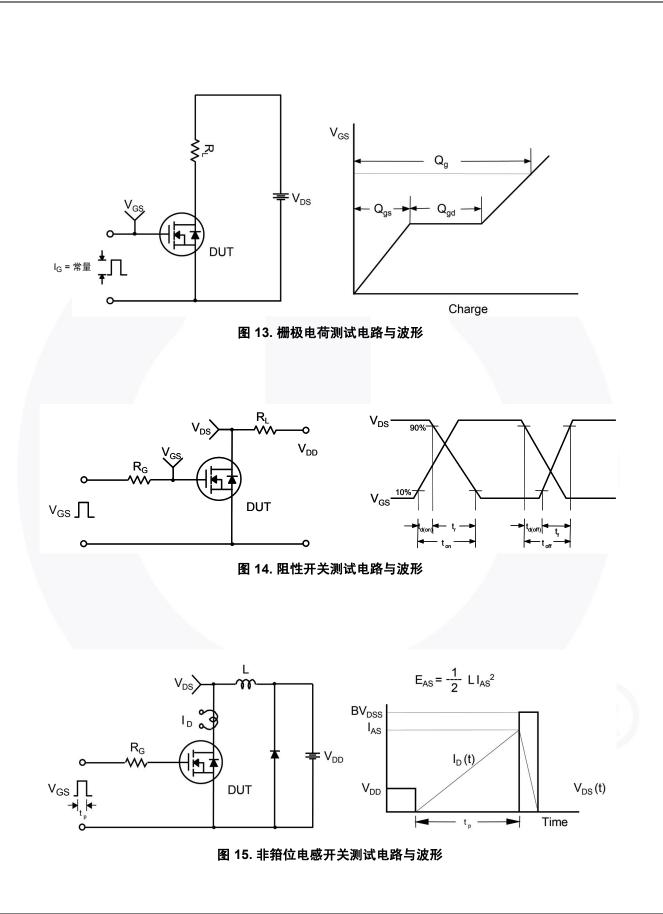




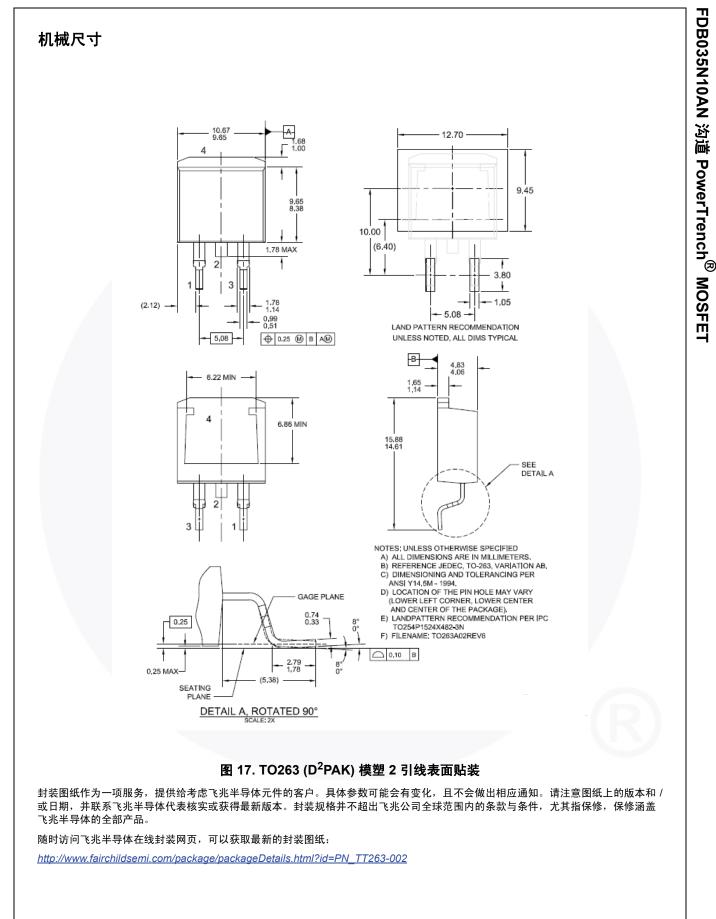


T_c, Case Temperature [°C]





DUT + v_{DS} ۱_{SD} م a L Driver R_G Same Type as DUT Ļ F ∨_{DD} ∏∏ V_{GS} • dv/dt controlled by R_{G} • I_{SD} controlled by pulse period ſ Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) \mathbf{I}_{FM} , Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop 图 16. 二极管恢复 dv/dt 峰值测试电路与波形





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